

# **FWS-2160**

## **Environment Test Report**

**Report NO: 13I020030**

Summary	<input checked="" type="checkbox"/> <b>Pass</b> <input type="checkbox"/> <b>Fail</b> <input type="checkbox"/> <b>Pass with Deviation</b>
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**Issue date**

**2013-11-01**

**Approval**

**Tom Lin**

**Test Engineer**

**Juno Cheng**

## Test item list

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### Testing Result

Num	Test item list	Result	Remark
1	Temperature rise test	Pass	
2	Temperature cycle operation test	Pass	
3	High temperature storage test	Pass	
4	Low temperature storage test	Pass	
5	Humidity test	Pass	
6	Cold start and hot start test	Pass	

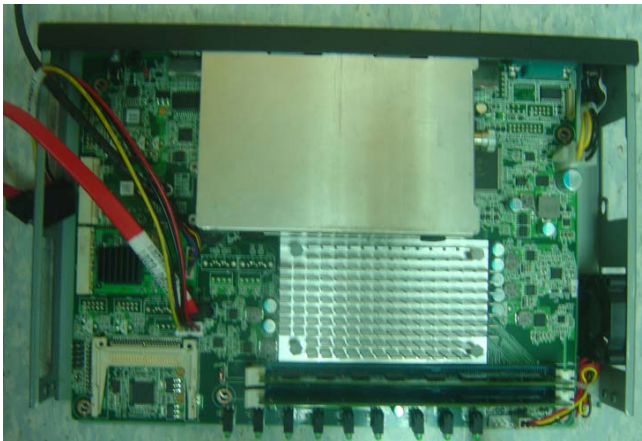
# Configuration of EUT

Num	Item	Spec
1	CPU	AMD G-T24L Processor 1.00GHz
2	CPU Board	FWS-2160 REV: A0.2
3	BIOS	FWS-2160 R0.5(K216AM05)(09/04/2013)
4	Chipset	AMD A50M
5	Memory(wide temp.)	DSL DDR3 1333 4GB CL9 ELPIDA J2108BDBG-GN-F*2
6	HDD	Western Digital WD1600BEVT 2.5" 160GB
7	Test Software	Windows 7 / Run PassMark Burn In Test 7.0 Pro

## HDD



## Heat Sink



# Temperature rise test

**Test Date:** 10-31-2013

**Test Product:** FWS-2160

**Test Site:** AAEMON QE Dept.

**Test Standard:** Refer to EN 61131-2(94), UL508 (94)

**Temperature Measurement:**

40 Channel Thermal Recorder: (YOKOGAWA Inc.)

Model: DA100-13-1D

Date of Calibration: 10/01/13

Serial Number: 12A323190

**Test Condition:**

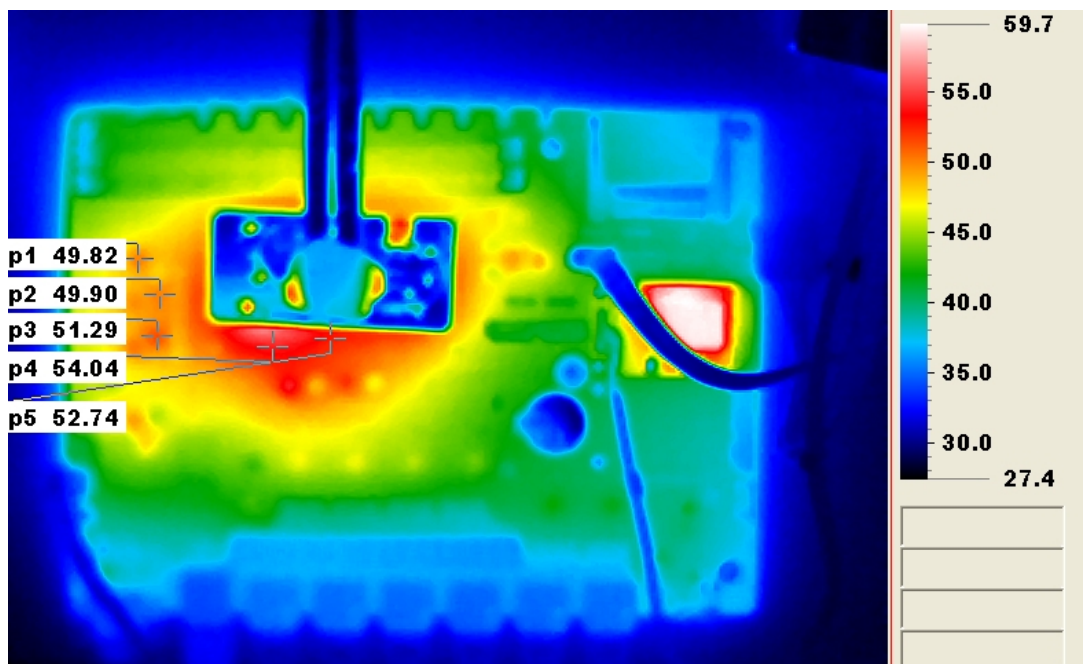
Ambient temperature: 40°C

Continuous running till thermal stability (within less than 1°C)

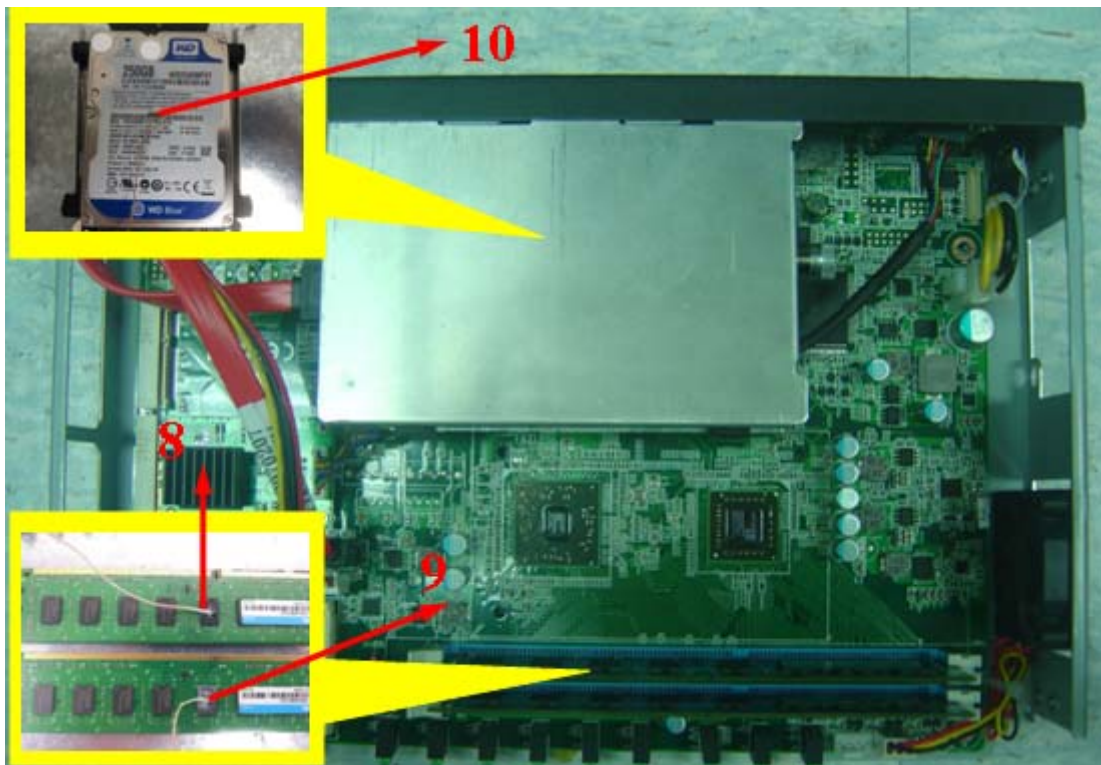
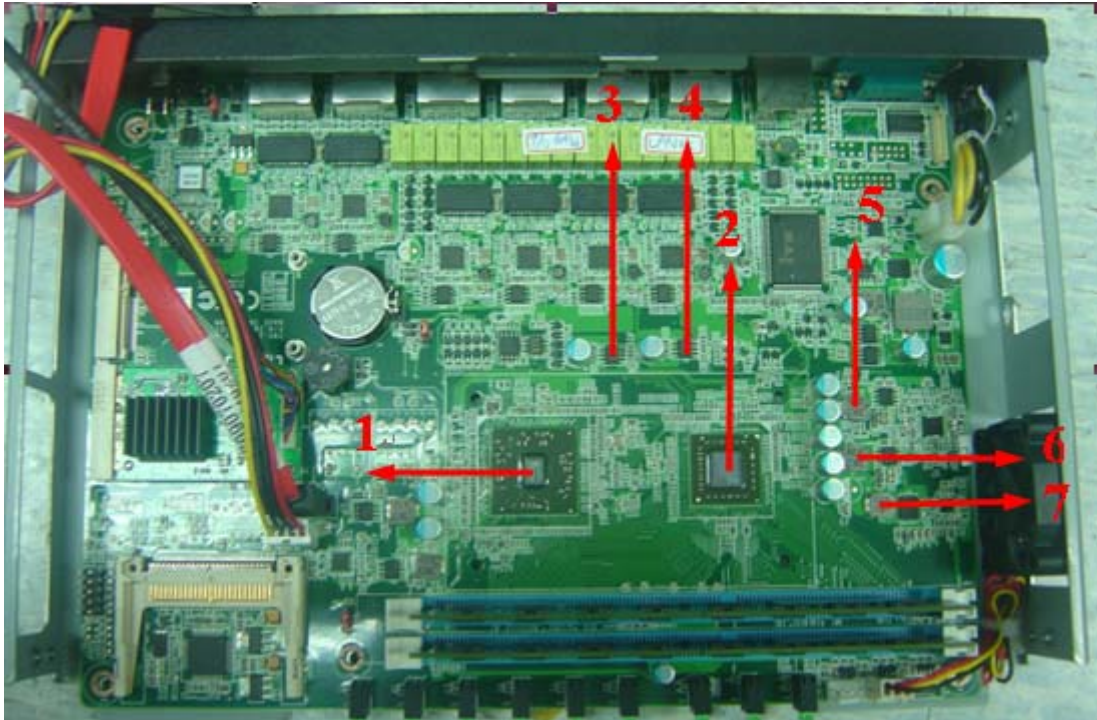
**Test Software:**

Windows 7 / Run PassMark Burn In Test 7.0 Pro

**Terminal Recorder:**



# Temperature rise test



# Temperature rise test



## Thermal profile data:

Point	Describe	Tc (*1) (°C)	Tm (*2) Measured Under		Note
			25°C	40°C	
1	U6 - (TF)AMD APU.G-series.1.0GHz.	90	60.2	75.2	
2	U7 - (TF)AMD.Hudson-M1 Fusion. Controller Hub..AMD.A50M	105	57.4	72.4	
3	U11 - (TF)Low dropout Linear Regulator.GMT.G9731F11U	100	47.9	62.9	
4	U9 - (TF)Low dropout Linear Regulator.GMT.G9731F11U	100	52.4	67.4	
5	L8 - (TF)COIL.2.2uH.Panasonic.ETQP3W2R2WFN	125	45.2	60.2	
6	L6 (TF)COIL.2.2uH. Panasonic.ETQP3W2R2WFN	125	45.9	60.9	
7	L3(TF)COIL.1uH. Panasonic.ETQP3W1R0WFN	125	47.1	62.1	
8	Memory - 1	95	42.2	57.2	
9	Memory - 2	95	43.0	58.0	
10	2.5" HDD surface	60	33.9	48.9	
11	System inside air temperature	N/A	29.9	44.9	
12	Housing surface temperature	N/A	31.5	46.5	

### Note(\*):

- "Tc" indicates the component's case maximum temperature value specified in its datasheet.
  - "Tm" indicates the measured Tc value under working environmental temperature within product specification.
- 3. Judgment Criteria:**
- **Fail** :  $T_m > T_c$ ; The measured value is over specification.
  - **Margin Pass** :  $T_c > T_m > T_c - 5^\circ\text{C}$ ; The measured value is within specification with margin.  
It is strongly recommended to add thermal dissipation design for better reliability.
  - **Pass** :  $T_m < T_c - 5^\circ\text{C}$ ; The measured value is with safety margin.

# Temperature rise test

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**Sample Configuration & Quantity Under Test:**

Quantity: 1 (FWS-2160)

**Test Result:**

No issues were found during the temperature rise operation test.

# Temperature cycle test

**Test Date:** 10-29 ~ 31-2013

**Test Product:** FWS-2160

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to IEC68-2-14 Testing procedures

Test N: Change of temperature Test

**Test Equipment:**

Programmable Temperature & Humidity Chamber: (K.SON. INS. TECH. CORP.)

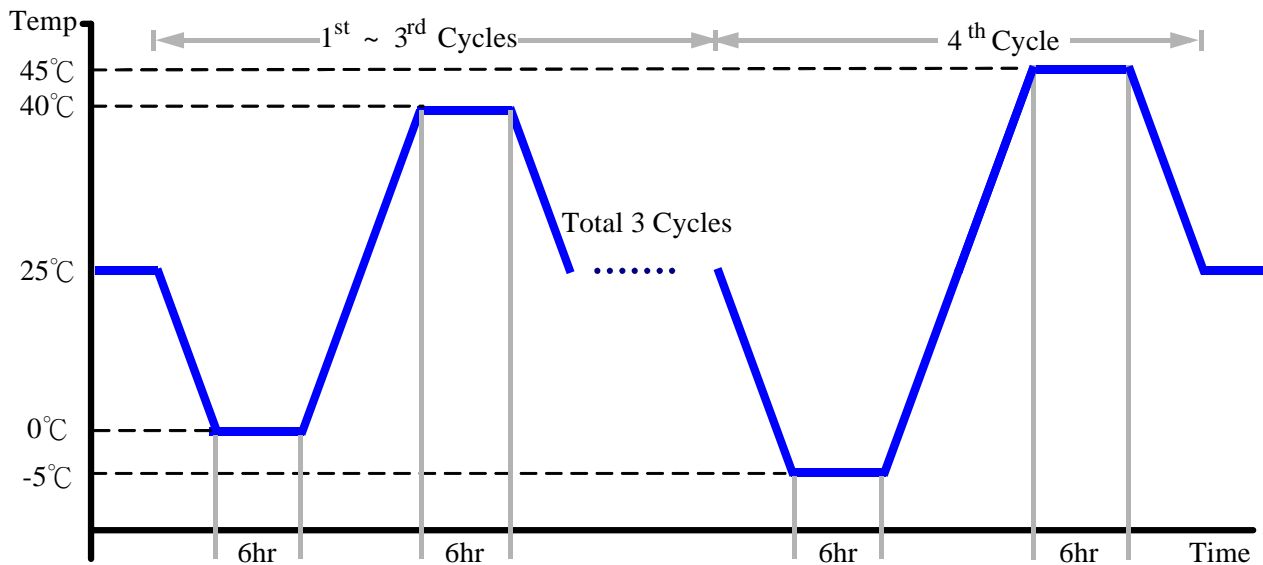
Model: THS-D4H+-100

Date of Calibration: 10/09/13

Serial Number: 2582

**Test Condition:**

1. Test Low Temperature: 0°C (1~3 cycles)  
-5°C (4<sup>th</sup> cycle)
2. Test High Temperature: 40°C (1~3 cycles)  
45°C (4<sup>th</sup> cycle)
3. Test dwell time: 6Hrs
4. Temperature slope: 2°C/min
5. Test cycle: 4 cycles
6. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (FWS-2160)

**Test Result:**

No issues were found during the temperature operation cycle test.



# High temperature storage test

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**Test Date:** 10-27 ~ 29-2013

**Test Product:** FWS-2160

**Test Site:** AAEON QE Dept.

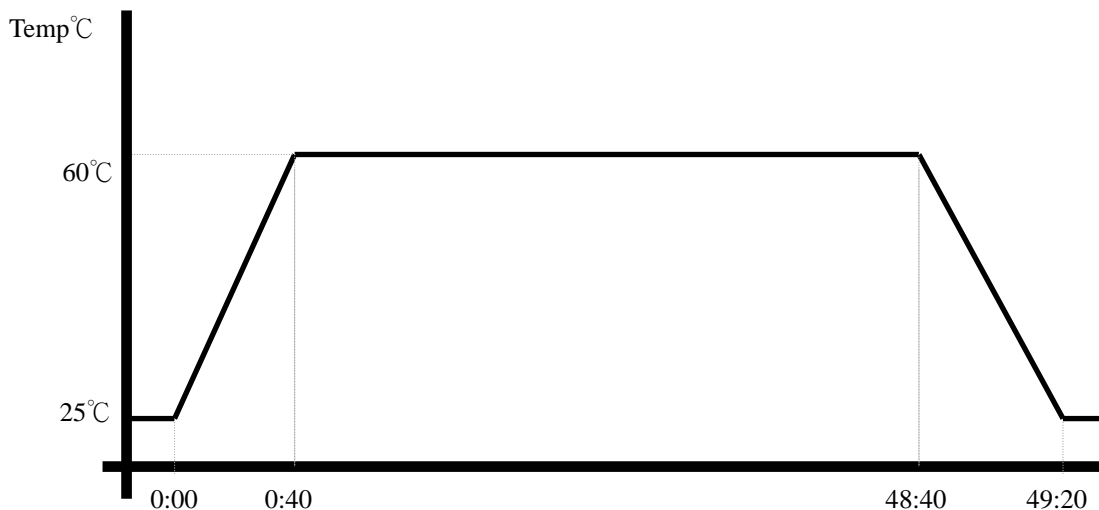
**Test Standard:** Refer to IEC 68-2-2 Testing procedures  
Test Bb: Dry Heat Test (Non-operation)

**Test Equipment:**

Programmable Temperature & Humidity Chamber: (K.SON. INS. TECH. CORP.)  
Model: THS-D4H+-100  
Date of Calibration: 10/09/13  
Serial Number: 2582

**Testing Item:**

1. Test Temperature: 60°C
2. Test Times: 48Hrs
3. Test Software: Windows 7 / Run PassMark Burn In Test 7.0 Pro
4. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (FWS-2160)

**Test Result:**

No issues were found after the high temperature storage test.

# Low temperature storage test

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**Test Date:** 10-25 ~ 27-2013

**Test Product:** FWS-2160

**Test Site:** AAeon QE Dept.

**Test Standard:** Refer to IEC 68-2-1 Testing procedures  
Test Ab: Cold Test (Non-operation)

**Test Equipment:**

Programmable Temperature & Humidity Chamber: (K.SON. INS. TECH. CORP.)

Model: THS-D4H+-100

Date of Calibration: 10/09/13

Serial Number: 2582

**Testing Item:**

1. Test Temperature: -20°C
2. Test Times: 48Hrs
3. Test Software: Windows 7 / Run PassMark Burn In Test 7.0 Pro
4. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (FWS-2160)

**Test Result:**

No issues were found after the low temperature storage test.

# Humidity test

**Test Date :** 10-23~25-2013

**Test Product:** FWS-2160

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to IEC 68-2-3 Testing procedures  
Test Ca: Damp heat, steady state (Non-operation)

**Test Equipment:**

Programmable Temperature & Humidity Chamber: (K.SON. INS. TECH. CORP.)

Model: THS-D4H+-100

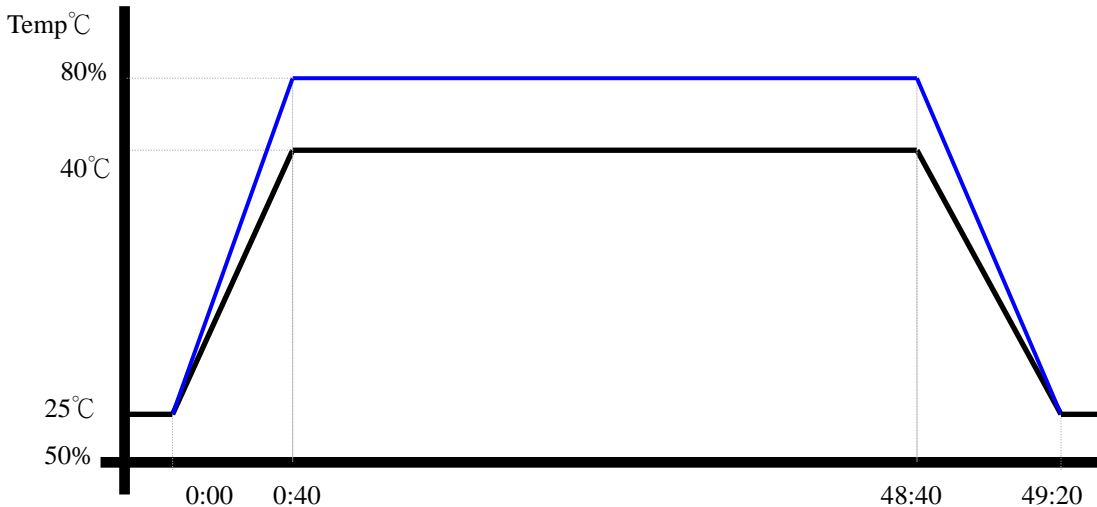
Date of Calibration: 10/09/13

Serial Number: 2582

**Testing Item:**

1. Test Temperature: 40°C
2. Test Humidity: 80%RH
3. Test Times: 48Hrs
4. Test Software: Windows 7 / Run PassMark Burn In Test 7.0 Pro
5. Test Environment Curve:

**Humidity %**



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (FWS-2160)

**Test Result:**

No issues were found after the humidity storage test.

# Cold start and hot start test

**Test Date:** 10-21~ 23-2013

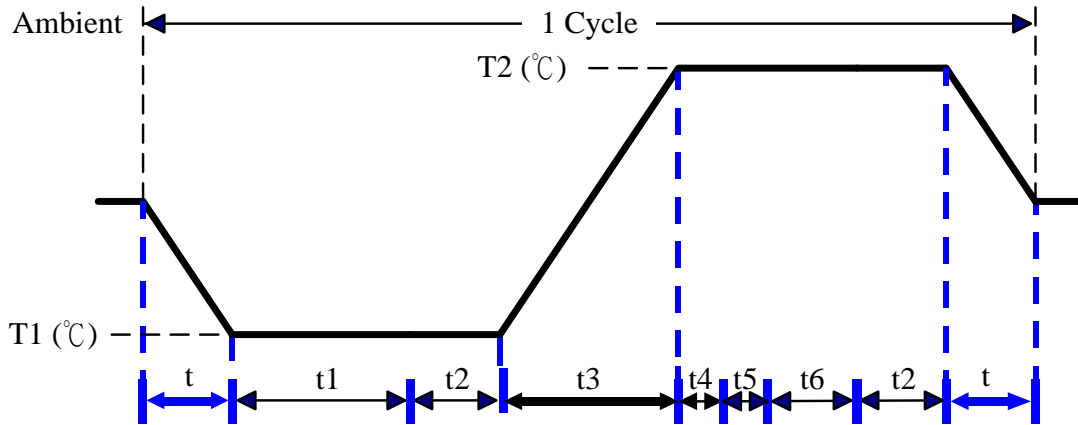
**Test Product:** FWS-2160

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to IEC 68-2-14 Testing procedures  
Test N: Change of temperature Test

**Test Equipment:**  
Programmable Temperature & Humidity Chamber: (K.SON. INS. TECH. CORP.)  
Model: THS-D4H+-100  
Date of Calibration: 10/09/13  
Serial Number: 2582

**Test Condition:**



Parameters	Description
T1	-5°C
T2	45°C
t1	4 hrs
t2, t6	2 hrs
t4, t5	1hrs
t, t3	2°C/min
n (Cycle)	1

t = temperature slope  
t, t1, t6: Power Off  
t2: Power on/off test 10 times (on 2 min / off 5min)  
t3, t4: Run burn in test 7.0  
t5: Win 7 Software restart test 3 times  
Test Software: Windows 7

**Test Result:**

- a. No issues were found during the cold start test.
- b. No issues were found during the hot start test.